#### \*Customer:

# **SPECIFICATION**

ITEM	TOP LED DEVICE			
MODEL	SSC-SUYT801			

# [Contents]

1.	Features	2
2.	Application	2
3.	Absolute Maximum Ratings	2
4.	Electro-optical Characteristics	2
5.	Soldering Profile	3
6.	Outline Dimension	4
7.	Packing	4
8.	Reel Packing Structure	5
9.	Precaution for Use	6
10.	Characteristic Diagram	7

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□ White colored SMT package and colorless clear window		White	colored	SMT	package	and	colorless	clear	window
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☐ Material : AlGaInP

□ Suitable for all SMT assembly methods ; Suitable for all soldering methods

#### 2. Application

□ Automotive

□ Electric appliance

□ Lightings

### 3. Absolute Maximum Ratings

(Ta=25°C)

Parameter Symbol		Value	Unit	
Power Dissipation	$P_d$	90	mW	
Forward Current	$I_F$	30	mA	
Peak Forward Current	$I_{FM}$ *2	90	mA	
Reverse Voltage	$V_R$	5	V	
Operating Temperature	$T_{opr}$	-40 ~ +100	°C	
Storage Temperature	$T_{stg}$	-40 ~ +100	°C	

<sup>\*1</sup>  $I_{FM}$  conditions: Pulse width  $Tw \le 0.1ms$ , Duty ratio  $\le 1/10$ 

Care is to be taken that Power Dissipation does not exceed the Absolute Maximum Rating of the product.

#### 4. Electro-Optical Characteristics

(Ta=25°C)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Forward Voltage	$V_F$	$I_F = 20 \text{mA}$	1.7	2.0	2.5	V
Reverse Current	$I_R$	$V_R=5V$	-	-	10	μΑ
Luminance Intensity*1	$I_V$	$I_F = 20 \text{mA}$	250	350	-	mcd
Peak Wavelength	$\lambda_P$	$I_F = 20 \text{mA}$	-	595	-	nm
Dominant Wavelength	$\lambda_d$	$I_F = 20 \text{mA}$	584	590	596	nm
Spectral Bandwidth 50%	Δλ	$I_F$ = 20mA	-	17	-	nm
Viewing Angle *2	201/2	$I_F = 20 \text{mA}$	-	120	-	deg.

<sup>\*1</sup> The luminous intensity  $I_V$  is measured at the peak of the spatial pattern which may not be aligned with the mechanical axis of the LED package. Luminous Intensity Measurement allowance is  $\pm 10\%$ 

[Note] All measurements were made under the standardized environment of SSC

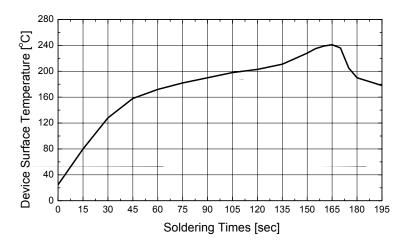
<sup>\*2</sup>  $\theta_{1/2}$  is the off-axis where the luminous intensity is 1/2 the peak intensity.

#### 5. Soldering Profile

#### (1) Reflow Soldering Conditions / Profile

Preliminary heat to be at maximum 150°C for maximum 2 minutes.

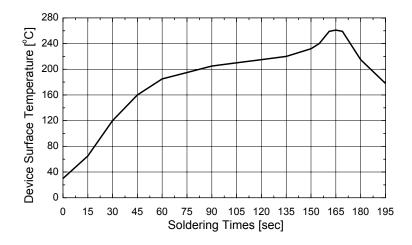
Soldering heat to be at maximum 240°C for maximum 10 seconds.



#### (2) Lead-free solder

Preliminary heating to be at maximum 220°C for maximum 2 minutes.

Soldering heat to be at maximum 260°C for maximum 10 seconds.

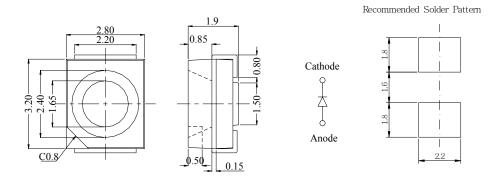


## (3) Hand Soldering conditions

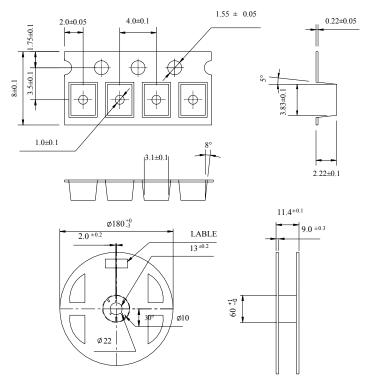
Not more than 5 seconds @MAX300°C, under Soldering iron.

In case the soldered products are reused in soldering process, we don't guarantee the products.

#### 6. Outline Dimension



# 7. Packing



( Tolerance:  $\pm 0.2$ , Unit: mm )

- (1) Quantity: 2000pcs/Reel
- (2) Cumulative Tolerance : Cumulative Tolerance/10 pitches to be  $\pm 0.2$ mm
- (3) Adhesion Strength of Cover Tape: Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at  $10^{\circ}$  angle to be the carrier tape

(4) Package: P/IN, Ivianufacturing data Code INO. and quantity to be indicated on a damp proof Package

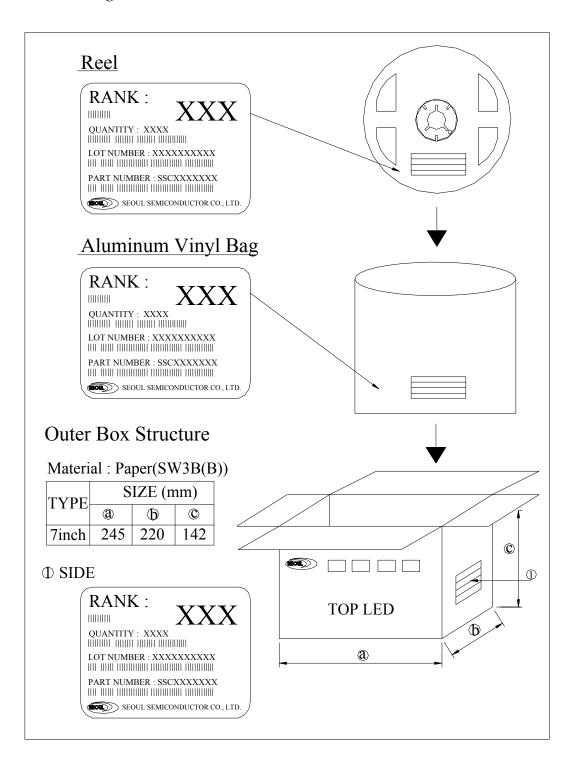
SSC-QP-0401-06(REV.0.1)

SEOUL SEMICONDUCTOR CO., LTD.

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#### 8. Reel Packing Structure



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- 5/7 -

#### 9. Precaution for use

(1) Storage

In order to avoid the absorption of moisture, it is recommended to store in a dry box (or a desiccator) with a desiccant. Otherwise, to store them in the following environment is recommended.

Temperature: 5°C ~30°C Humidity: maximum 60%HR

- \* The LED is classified to Class 3 by JEDEC (J-STD-020A and J-STD-033).
- (2) Attention after open.

LED is correspond to SMD, when LED be soldered dip, interfacial separation may affect the light transmission efficiency, causing the light intensity to drop. Attention in followed;

- a. After opened and mounted the soldering shall be quickly.
- b. Keeping of a fraction

Temperature :  $5 \sim 40^{\circ}$ C Humidity : less than 30%

- (3) In the case of more than 1 week passed after opening or change color of indicator on desiccant, components shall be dried 10-12hr. at  $60\pm5$ °C.
- (4) In the case of that the components is humided, the components shall be dried;

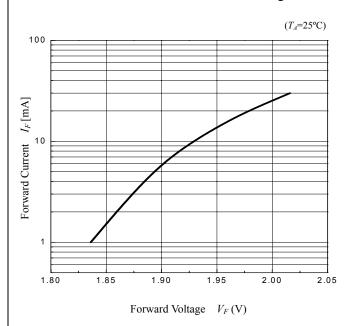
24Hr at  $80\pm5$ °C or 12Hr at  $100\pm5$ °C.

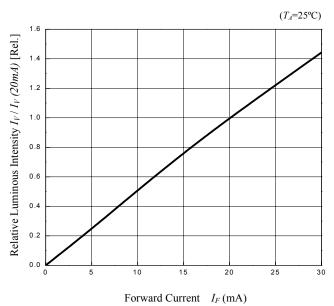
- (5) Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temperature after soldering.
- (6) Quick cooling shall be avoided.
- (7) Components shall not be mounted on warped direction of L/F.
- (8) Anti radioactive ray design is not considered for the products.
- (9) This device should not be used in any type of fluid such as water, oil, organic solvent etc. When washing is required, IPA should be used.
- (10) When the LEDs are illuminating, operating current should be decided after considering the ambient maximum temperature.
- (11) LEDs must be stored to maintain a clean atmosphere. If the LEDs are stored for 3 months or more after being shipped from SSC, a sealed container with a nitrogen atmosphere should be used for storage.
- (12) The LEDs must be soldered within seven days after opening the moisture-proof packing.
- (13) Repack unused products with anti-moisture packing, fold to close any opening and then store in a dry place.
- (14) The appearance and specifications of the product may be modified for improvement without notice.

# 10. Characteristic Diagram

#### Forward Current vs Forward Voltage

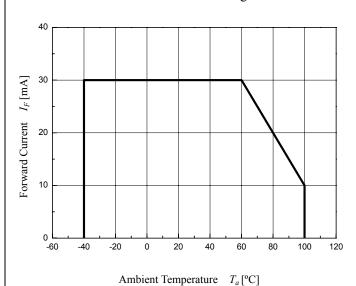
#### Relative Luminous Intensity vs. Forward Current

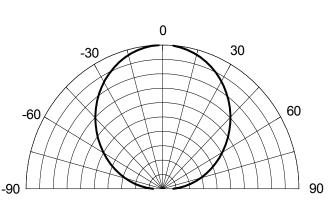




#### Forward Current Derating Curve

# Radiation Diagram





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- 7/7 -

SSC-SUYT801

 $(T_A = 25^{\circ}\text{C})$